cRIO-9042 Specifications



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CN10-3042	_

cRIO-9042 Specifications

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- *Typical* specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are *Typical* unless otherwise noted.

Conditions

Specifications are valid for -40 °C to 70 °C unless otherwise noted.

Processor

CPU	Intel Atom E3940
Number of cores	4
CPU frequency	1.6 GHz (base), 1.8 GHz (burst)
On-die L2 cache	2 MB

Software



Note For minimum software support information, visit <u>ni.com/r/SWsupport</u>.

Supported operating system		NI Linux Real-Time (64-bit)
Supported C Series module programming modes		Real-Time (NI-DAQmx) Real-Time Scan (I/O Variables) LabVIEW FPGA
Application software		
LabVIEW 2017 or later, LabVIEW Real-Time Module 2017 or later, LabVIEW FPGA Module 2017 or later		



Note LabVIEW FPGA Module is not required when using Real-Time Scan (I/O Variables) mode or Real-Time (NI-DAQmx) mode. To program the user-accessible FPGA on the cRIO-9042, the LabVIEW FPGA Module is required.



Note C/C++ Development Tools for NI Linux Real-Time is an optional interface for C/C++ programming of the cRIO-9042 processor. Visit <u>ni.com/r/RIOCdev</u> for more information about the C/C++ Development Tools for NI Linux Real-Time. For information on setting up a C/C++ based toolchain, visit <u>ni.com/r/NILRTCrossCompile</u>.

Orivers December 2017 or later

Network/Ethernet Port

Number of ports	2
Network interface	10Base-T, 100Base-TX, and 1000Base-T Ethernet
Compatibility	IEEE 802.3
Communication rates	10 Mb/s, 100 Mb/s, 1,000 Mb/s, auto-negotiated
Maximum cabling distance	100 m/segment

Network Timing and Synchronization

Protocol	IEEE 802.1AS-2011 IEEE 1588-2008 (default end-to-end profile)
Supported Ethernet ports	Port 0, port 1
Network synchronization accuracy	<1 μs



Note Network synchronization is system-dependent. For information about network synchronization accuracy, visit <u>ni.com/r/criosync</u>.



Note The cRIO-9042 employs time-aware transmission support.

RS-232 Serial Port

Maximum baud rate	115,200 b/s
Data bits	5, 6, 7, 8
Stop bits	1, 2
Parity	Odd, even, mark, space
Flow control	RTS/CTS, XON/XOFF, DTR/DSR
RI wake maximum low level	0.8 V
RI wake minimum high level	2.4 V
RI overvoltage tolerance	±24 V

RS-485 Serial Port

Maximum baud rate	230,400 b/s	
Data bits	5, 6, 7, 8	
Stop bits	1, 2	

Parity	Odd, even, mark, space		
Flow control	XON/XOFF		
Wire mode	4-wire, 2-wire auto		
Isolation voltage	60 V DC continuous, port to earth ground		



Note The RS-485 serial port ground and shield are functionally isolated from chassis ground to prevent ground loops, but do not meet IEC 61010-1 for safety isolation.

Cable requirement	Unshielded, 30 m maximum length (limited by EMC/surge)



Note RS-485 is capable of 1.2 km (4,000 ft) length without surge limitation.

USB Ports

Port 1: •←		
Туре	USB Type-A, host port	
USB interface	USB 2.0, Hi-Speed	
Maximum data rate	480 Mb/s	

Maximum current			900 mA
Port 2: <i>ss</i> ← 🕟			
Туре		USB Type-C, host port	
USB interface		USB 3.1 Gen1, SuperSpeed	
Maximum data rate		5 Gb/s	
Maximum current		900 mA	
Alternate modes		DisplayPort	
Port 3: <i>ss</i> ←			
Туре	USB Type-C, dual role port (device or host)		
USB interface	USB 3.1 Gen1, SuperSpeed		
Maximum data rate	5 Gb/s		
Maximum current	900 mA		

DisplayPort over USB Type-C

Maximum resolution	3840 × 2160 at 60 Hz

Supported standard	DisplayPort 1.2
Supported USB ports	Port 2: <i>ss</i> ← ®

SD Card Slot

SD card support	SD and SDHC standards
Supported interface speeds	UHS - I SDR50 and DDR50



Notice Full and high speed SD cards are prohibited for use with the cRIO-9042.

Memory

Nonvolatile memory (SSD)	4 GB
Nonvolatile memory (SSD) type	Planar SLC NAND



Note Visit <u>ni.com/r/ssdbp</u> for information about the life span of the nonvolatile memory and about best practices for using nonvolatile memory.

Volatile memory (DRAM)	
Density	4 GB

Туре	DDR3L
Maximum theoretical data rate	12.8 GB/s

Reconfigurable FPGA

FPGA type	Xilinx Kintex-7 7K70T
Number of flip-flops	82,000
Number of 6-input LUTs	41,000
Number of DSP slices (18 × 25 multipliers)	240
Available block RAM	4,860 kbits
Number of DMA channels	16
Number of logical interrupts	32

Internal Real-Time Clock

Accuracy

Controller PFI 0

Maximum input or output frequency		1 MHz	
Cable length		3 m (10 ft)	
Cable impedance		50 Ω	
PFI 0 connector		SMB	
Power-on state		High impedance	
I/O standard compatibility		5 V TTL	
I/O voltage protection		±30 V	
Maximum operating conditions			
I _{OL} output low current 8 mA ma		ximum	
I _{OH} output high current -8 m/		-8 mA maximum	

Table 1. DC Input Characteristics

Voltage	Minimum	Maximum
Positive going threshold	1.43 V	2.28 V
Negative going threshold	0.86 V	1.53 V
Hysteresis	0.48 V	0.87 V

Table 2. DC Output Characteristics

Voltage	Conditions	Minimum	Maximum
High	_	_	5.25 V
	Sourcing 100 μA	4.65 V	_
	Sourcing 2 mA	3.60 V	_
	Sourcing 3.5 mA	3.44 V	_
Low	Sinking 100 μA	_	0.10 V
	Sinking 2 mA	_	0.64 V
	Sinking 3.5 mA	_	0.80 V

Real-Time Streaming Performance

Data throughput is dependent on the application, system, and performance of the removable storage media. For information about optimizing data throughput on the cRIO-9042, visit <u>ni.com/r/optdata</u>.

Data throughput from system memory to target	
SD card	40 MB/s
USB Type-C	100 MB/s

Real-Time (NI-DAQmx) Mode

The following specifications are applicable for modules and slots programmed in Real-Time (NI-DAQmx) mode. For more information about using modules in LabVIEW FPGA mode or Real-Time Scan (I/O Variables) mode, visit <u>ni.com/r/swsupport</u>.

Analog Input

Input FIFO size	253 samples per slot
Maximum sample rate	Determined by the C Series module or modules
Timing accuracy	50 ppm of sample rate
Timing resolution	12.5 ns
Number of channels supported	Determined by the C Series module or modules
Number of hardware-timed tasks	8



Note Maximum sample rate performance is dependent on type of installed C Series module and number of channels in the task.



Note Timing accuracy does not include group delay. For more information, refer to the documentation for each C Series module.

Analog Output

Hardware-timed tasks		
Number of hardware-timed tasks		8
Number of channels supported		
Onboard regeneration 16		

Non-regeneration	Determined by the C Series module or modules		
Non-hardware-timed tasks	1		
Number of non-hardware-timed tasks		Determined by the C Seri	es module or modules
Number of channels supported		Determined by the C Seri	es module or modules
Maximum update rate			1.6 MS/s



Note Streaming applications are limited by system-dependent factors and the capability of C Series modules.

Timing accuracy	50 ppm of sample rate
Timing resolution	12.5 ns
Waveform onboard regeneration FIFO	8,191 samples shared among channels used
Waveform streaming FIFO	253 samples per slot

Digital Waveform

Waveform acquisition (DI) FIFO	
Parallel modules	255 samples per slot

Serial modules		127 sa	mples per slot	
Waveform onboard regenerat	ion (DO) FIFO)		
Parallel modules 2,047 samples		es shared	s shared among slots used	
Waveform streaming (DO) FIF	О			
Parallel modules		255 sai	255 samples per slot	
Serial modules		127 samples per slot		
Sample clock frequency				
Digital input		0 MHz to	0 MHz to 10 MHz	
Digital output				
ot0:6 timing engine			0 MHz to 3.5 MHz	
ot7 timing engine			0 MHz to 10 MHz	



Note Streaming applications are limited by system-dependent factors and the capability of C Series modules.

Timing accuracy	50 ppm
Number of digital input hardware-timed tasks	8

Number of digital output hardware-timed tasks	8	

General-Purpose Counters/Timers

Number of counters/ timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, semi-period, period, two-edge separation, pulse width
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	80 MHz, 20 MHz, 13.1072 MHz, 12.8 MHz, 10 MHz, 100 kHz
External base clock frequency	0 MHz to 20 MHz
Base clock accuracy	50 ppm
Output frequency	0 MHz to 20 MHz

Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down
Routing options for inputs	Any module PFI, controller PFI, analog trigger, many internal signals
FIFO	Dedicated 127-sample FIFO

Frequency Generator

Number of channels	1
Base clocks	20 MHz, 10 MHz, 100 kHz
Divisors	1 to 16 (integers)
Base clock accuracy	50 ppm
Output	Any controller PFI or module PFI terminal

Module PFI

Functionality	Static digital input, static digital output, timing input, and timing output
Timing output sources	Many analog input, analog output, counter, digital input, and digital output timing signals

Timing input frequency	0 MHz to 20 MHz
Timing output frequency	0 MHz to 20 MHz



Note Actual available timing output source signals are dependent on type of installed C Series module.

Digital Triggers

Source	Any controller PFI or module PFI terminal		
Polarity	Software-selectable for most signals		
Analog input function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase		
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase		
Counter/timer function	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down		

Module I/O States

At power-on

Time-Based Triggers and Timestamps

Number of time-based triggers 5			5	
Number of timestamps 6			6	
Analog input				
Time-based triggers	Start Trigger, Sync Pulse			
Timestamps	Start Trigger, Reference Trigger, First Sample			
Analog output				
Time-based triggers		Start Trigger, Sync Pulse		
Timestamps		Start Trigger, First Sample		
Digital input	I			
Time-based triggers	Start Trigger			
Timestamps	Start Trigger, Reference Trigger, First Sample			
Digital output				
Time-based triggers		Start Trigger		
Timestamps		Start Trigger, First Sample		
Counter/timer input				

Time-based triggers		Arm Start Trigger
Timestamps		Arm Start Trigger
Counter/timer output		
Time-based triggers	Start Trigger, Arm Start Trigger	
Timestamps	Start Trigger	, Arm Start Trigger

CMOS Battery

Typical battery life with power applied to power connector	10 years
Typical battery life when stored at temperatures up to 25 °C	7.8 years
Typical battery life when stored at temperatures up to 85 °C	5.4 years

Power Requirements



Note Some C Series modules have additional power requirements. For more information about C Series module power requirements, refer to the C Series module(s) documentation.



Note Sleep mode for C Series modules is not supported in Real-Time (DAQmx) Mode.

Voltage input range (measured at the cRIO-9042 power connector)

V1	9 V to 30 V	
V2	9 V to 30 V	
Maximum power consumption		60 W



Note The C terminal of the power connector is functionally isolated from chassis ground to prevent ground loops, but does not meet IEC 61010-1 for safety isolation



Note The maximum power consumption specification is based on a fully populated system running a high-stress application at elevated ambient temperature and with all C Series modules and USB devices consuming the maximum allowed power.

Typical standby power consumption		3.4 W at 24 V DC input
Recommended power supply		100 W, 24 V DC
Typical leakage current from secondary power input (V2) while system is powered from primary power input (V1)		
At 9 V	0.4 mA	
At 30 V	1.93 mA	



Notice Do not connect V2 to a DC Mains supply or to any supply that requires a connecting cable longer than 3 m(10 ft). A DC Mains supply is a local DC electricity supply network in the infrastructure of a site or building. V1 may be connected to DC Mains.



Notice Include a switch or circuit breaker in the installation to disconnect the system from DC Mains. The switch or circuit breaker must be suitably rated, accessible, and marked as the disconnecting device for the system.

EMC ratings for inputs as described in IEC 61000			
V1	Short lines, long lines, and DC distributed networks		
V2	Short lines only		
·		4-position, 3.5 mm pitch, pluggable screw terminal with screw locks, Sauro CTF04BV8-AN000A	

Battery Guidelines



Caution Fire, explosion, and severe burn hazard. Do not open, crush, insert improperly, recharge or disassemble the battery. Do not heat the battery or the product above 100 °C. Do not incinerate the battery or the product. Do not expose the battery contents to water. Take precautions to ensure correct polarity of the battery in the product. Risk of explosion if battery is replaced by an incorrect type. Dispose of used batteries according to the instructions.



Attention Risque d'incendie, d'explosion et de brûlures graves. Ne pas ouvrir, écraser, recharger ou démonter la pile. Ne pas chauffer la pile ou le produit au-dessus de 100 °C. Ne pas incinérer la pile ou le produit. Éviter tout contact du contenu de la pile avec de l'eau. Prenez des précautions pour vous assurer que la polarité de la batterie dans le produit est correcte. Risque d'explosion si la pile est remplacée par un type de pile incorrect. Reportezvous à la documentation de l'appareil sur ni.com/manuals pour obtenir des

informations sur le remplacement, l'élimination et le recyclage de sa pile.



Caution The battery must be replaced by a trained service technician. Refer to the product documentation on ni.com/manuals for instructions for replacing the battery.



Attention La pile doit être remplacée par un technicien de maintenance qualifié. Reportez-vous à la documentation du produit sur ni.com/manuals pour obtenir les instructions pour changer la pile.

Battery Rating		
Manufacturer	Tadiran	
Model	TLH-2450/P	
Quantity	1	
Cell chemistry system	Lithium Thionyl Chloride	

Physical Characteristics

Weight (unloaded)	1,800 g (3 lb, 15 oz)		
Dimensions (unloaded)	219.5 mm × 88.1 mm × 121.2 mm (8.64 in. × 3.47 in. × 4.77 in.)		
Power connector wiring			
Gauge	0.5 mm ² to 2.1 mm ² (20 AWG to 14 AWG) copper conductor wire		

Wire strip length	6 mm (0.24 in.) of insulation stripped from the end			
Temperature rating	85°	С		
Torque for screw terminals	0.20	0.20 N · m to 0.25 N · m (1.8 lb · in. to 2.2 lb · in.)		
Wires per screw terminal	One wire per screw terminal			
Connector securement				
Securement type		Screw flanges provided		
Torque for screw flanges		0.20 N · m to 0.25 N · m (1.8 lb · in. to 2.2 lb · in.)		
Insulation rating 300 V,		maximum		

Safety Voltages

Connect only voltages that are below these limits.

V1 terminal to C terminal	30 V, maximum
V2 terminal to C terminal	30 V, maximum
Chassis ground to C terminal	30 V, maximum

Environmental Characteristics

Temperature					
Operating		-40 °C to 70 °C			
Storage		-40 °C to 85 °C			
Humidity					
Operating	10% RH to 90% RH, noncondensing				
Storage	5% RH to 95% RH, noncondensing				
Ingress protection			IP20		
Pollution Degree			2		
Maximum altitude			5,000 m		
Shock and Vibration					
Operating vibration					
Random 5 g RMS, 1		, 10 Hz to 500 Hz			
Sinusoidal 5 g, 10 Hz to 500 Hz			to 500 Hz		
Operating shock 30 g, 11 ms half sine; 50 g, 3 ms half sine; 18 shocks at 6 orientations					

To meet these specifications, you must mount the cRIO-9042 system directly on a flat, rigid surface as described in the user manual, affix ferrules to the ends of the terminal wires, and use retention accessories for the USB 2.0 host port (NI USB Extender Cable, 152166-xx), USB type-C ports (NI Locking USB Cables, 143556-xx; NI USB Extender Cable, 143555-xx; NI USB Display Adapters, 143557-xx or 143558-xx). All cabling should be strain-relieved near input connectors. Take care to not directionally bias cable connectors within input connectors when applying strain relief.